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ROVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 23
David Chang		VERSION: 2
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
(MO	DEL NO.:	
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	(RoHS)	
FOR	MESSRS:	
CUSTOMER'S APPROV	AL	
DATE:		
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MODEL NO. VERSION PAGE EMERGING DISPLAY TECHNOLOGIES CORPORATION ETV570G2DMU 0 - 1DOC . FIRST ISSUE APR.21, 2009 RECORDS OF REVISION REVISED DATE PAGE SUMMARY NO. AUG.25, 2009 4. ELECTRICAL CHARACTERISTICS POWER SUPPLY CURRENT FOR VCOM DRIVER: TYP.= $(540) \rightarrow 550$, MAX.= $(700) \rightarrow 710$

E M E R G I N G D I S P L A Y TECHNOLOGIES CORPORATION

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1. GENERAL SPECIFICATIONS 1. 1 APPLICATION NOTES FOR CONTROLLER/DRIVER PLEASE REFER TO: HIMAX HX8250 HIMAX HX8678 1. 2 MATERIAL SAFETY DESCRIPTION ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMEN INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING I MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINAT BIPHENYLS (PBB) AND POLYBROMINATED DIPHENYL ETHERS (PBDE) 2. MECHANICAL SPECIFICATIONS (1) DIAGONALS (2) NUMBER OF DOTS (3) MODULE SIZE	LEAD
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(1) DIAGONALS	
(3) MODULE SIZE 147.6W * 100H *10D (MAX) mm (WITHOUT FPC) (4) EFFECTIVE AREA 117.2W * 88.4H mm	
(WITHOUT FPC) (4) EFFECTIVE AREA	
(4) EFFECTIVE AREA 117.2W * 88.4H mm	
` '	
(5) ACTIVE AREA 115.2W * 86.4H mm	
(6) DOT SIZE 0.06W * 0.18H mm	
(7) PIXEL SIZE 0.18W * 0.18H mm	
(8) LCD TYPE TFT, TRANSMISSIVE	
(9) COLOR 262K	
(10) VIEWING DIRECTION 12 O'CLOCK	
(11) BACK LIGHT LED, COLOR: WHITE	3.1.O.D.
(12) INTERFACE MODE RGB 18BIT PARALLEL (DE/SYNC) MODI

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3. ABSOLUTE MAXIMUM RATINGS

3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY	VDD-VSS	-0.3	7.0	V	
VOLTAGE	VCC-VSS	-0.3	7.0	V	
INPUT SIGNAL VOLTAGE	VIN-VSS	- 0.3	VCC+0.3	V	
STATIC ELECTRICITY				V	NOTE (1)
LED BACKLIGHT POWER	PD		1.28	W	
DISSIPATION	1 D		1.20	**	
LED BACKLIGHT FORWARD	IF		60	mA	
CURRENT	11		00	ША	
LED BACKLIGHT	VR		45	V	
REVERSE VOLTAGE	VK		43	V	

NOTE (1): LCM SHOULD BE GROUNDED DURING HANDING LCM.

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

ITEM	OPERATING		STORAGE		REMARK	
I I E IVI	MIN.	MAX.	MIN.	MAX.	KLIVIAKK	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE (1), (2)	
HUMIDITY	NOTI	E (2)	NOTE (2)		WITHOUT	
HOMIDIT I	NOTI	NOTE (3) NOTE (3) CONDENS.		CONDENSATION		
VIBRATION		3.92 m/s^2		19.6 m/s^2	10~55Hz	
VIBRATION	<u> </u>	(0.4 G)		(2.0 G)	X, Y, Z, EACH 2HRS	
					6 m SECONDS	
SHOCK		58.8 m/s^2		490 m/s^2	XYZ	
SHOCK		(6G)	_	(50G)	DIRECTIONS	
					3 TIMES EACH	
CORROSIVE GAS	NOT ACCEPTABLE		NOT ACCEPTABLE			

NOTE (1): Ta AT -30°C: 48HR MAX.

80°C:168HR MAX.

NOTE (2): BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT

TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

NOTE (3): $Ta \le 60^{\circ}C : 90\%RH \text{ MAX } (96HRS \text{ MAX}).$

 $\text{Ta} > 60 ^{\circ}\text{C}: AB\text{SOLUTE}$ HUMIDITY MUST BE LOWER THAN THE HUMIDITY

OF 90%RH AT 60°C(96HRS MAX).

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4. ELECTRICAL CHARACTERISTICS

 $Ta = 25 \, ^{\circ}C$

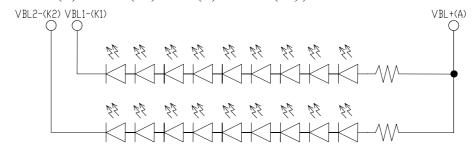
						1a - 25 C
SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
VDD-VSS		3	3.3	3.6	V	
VCC-VSS		3	3.3	3.6	V	
IDD	VDD-VSS =3.3V		8	12	mA	NOTE (1)
ICC	VCC-VSS = 3.3V LED B/L=ON	_	550	710	mA	
VIL		0	_	0.3*VDD	V	NOTE (2)
VIH	_	0.7*VDD	_	VDD	V	NOTE (2)
VOL	$IOL = 400 \mu A$	0	_	0.2*VDD	V	NOTE (2)
VOH	$IOH = -400 \mu A$	0.8*VDD		VDD	V	NOTE (3)
fFRAME		50	60	72	Hz	
V_{F}	I _F =40mA	28	30	32	V	NOTE (4)
		30000	40000		HRS	
	VDD-VSS VCC-VSS IDD ICC VIL VIH VOL VOH fFRAME	VDD-VSS — VCC-VSS — IDD VDD-VSS = 3.3V VCC-VSS = 3.3V LED B/L=ON VIL — VIH — VOL IOL = 400μA VOH IOH = -400μA fframe —	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	VDD-VSS — 3 3.3 VCC-VSS — 3 3.3 IDD VDD-VSS =3.3V — 8 ICC = 3.3V — 550 VIL — 0 — VIL — 0.7*VDD — VIH — 0.7*VDD — VOL IOL = 400μA 0 — VOH IOH = -400μA 0.8*VDD — fFRAME — 50 60 V _F I _F =40mA 28 30	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	VDD-VSS — 3 3.3 3.6 V VCC-VSS — 3 3.3 3.6 V IDD VDD-VSS = 3.3V = - 8 12 mA ICC = 3.3V = - 550 710 = mA VIL — 0 — 0.3*VDD V VIH — 0.7*VDD — VDD V VOL IOL = 400μA 0 — 0.2*VDD V VOH IOH = -400μA 0.8*VDD — VDD V fFRAME — 50 60 72 Hz V _F I _F =40mA 28 30 32 V

NOTE (1): THE DISPLAY PATTERN IS ALL "WHITE".

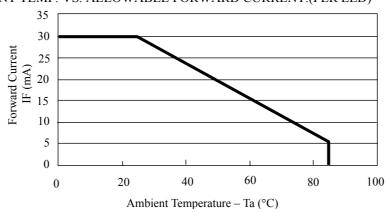
NOTE (2): APPLIED TO TERMINALS / RESET, HSYNC, VSYNC, ENB, DCLK, B5~B0, G5~G0, R5~R0.

NOTE (3): APPLIED TO TERMINALS B5~B0, G5~G0, R5~R0.

NOTE (4): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT (VF=VBL+(A)—VBL1-(K1)=VBL+(A)—VBL2-(K2))



NOTE (5): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT.(PER LED)

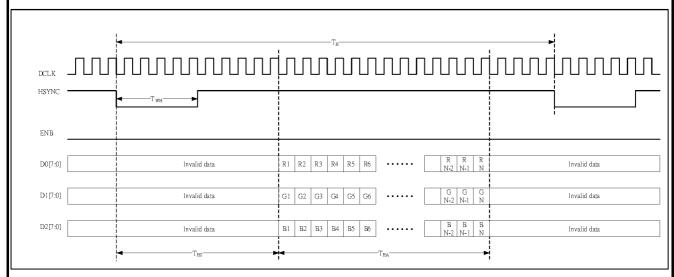


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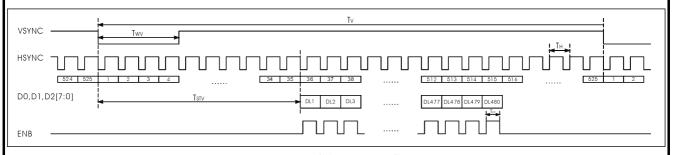
5. TIMING CHARACTERISTICS

5.1 DIGITAL PARALLEL RGB INTERFACE (SYNC MODE)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQUENCY	F_{CPH}	22.66	25.175	27.69	MHz
DCLK PERIOD	T_{CPH}	36.11	39.7	44.13	ns
DCLK PULSE DUTY	T_{CWH}	40	50	60	%
HSYNC PERIOD	T_{H}	750	800	850	T_{CPH}
HSYNC PULSE WIDTH	$T_{ m WH}$	5	30	_	T_{CPH}
HSYNC FIRST HORIZONTAL DATA TIME	T_{HS}	112	144	175	T_{CPH}
HORIZONTAL ACTIVE DATA AREA	T_{HA}	_	640	_	T_{CPH}
VSYNC PULSE WIDTH	T_{WV}	1	3	5	T_{H}
FIRST LINE DATA INPUT TIME	T_{STV}	_	35	_	T_{H}
VSYNC PERIOD	$T_{\mathbf{V}}$	515	525	535	T_{H}



HORIZONTAL TIMING

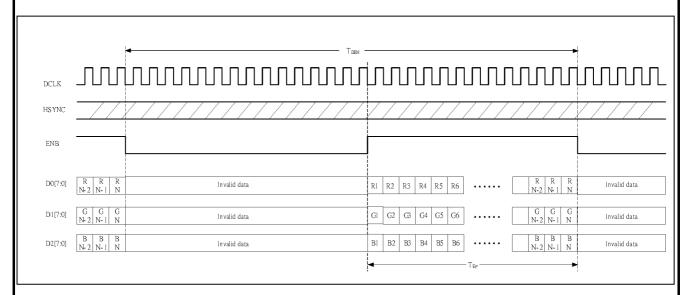


VERTICAL TIMING

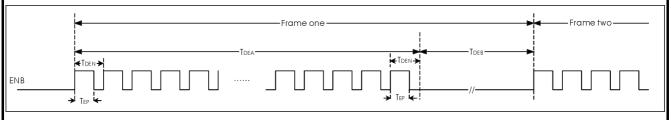
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5.2 DIGITAL PARALLEL RGB INTERFACE (DE MODE)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQUENCY	F_{CPH}	22.66	25.175	27.69	MHz
DCLK PERIOD	T_{CPH}	36.11	39.7	44.13	ns
DCLK PULSE DUTY	T_{CWH}	40	50	60	%
ENB PERIOD	T_{DEN}	750	800	850	T_{CPH}
ENB PULSE WIDTH	T_{EP}	_	640		T_{CPH}
ENB FRAME ACTIVE TIME	T_{DEA}	_	480	_	T_{DEN}
ENB FRAME BLANKING TIME	T_{DEB}	10	45	110	T_{DEN}



HORIZONTAL TIMING



VERTICAL TIMING

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$6. \quad OPTICAL \ CHARACTERISTICS \ (NOTE1)$

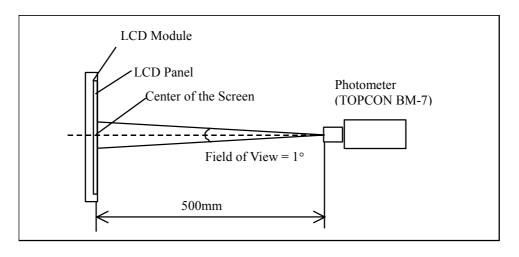
6.1 OPTICAL CHARACTERISTICS

 $Ta = 25 \pm 2$ °C

I T E M		SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK	
		θ_{y^+}	CD > 10	0 -00	50	55	_	1	NOTE(2)	
VIEWING ANGL	THEM IN CANCEL			$\theta^{x}=0$ °	47	52				
VIEWING ANGL	Æ	θ_{x^+}	CR ≥ 10	60		60	65		deg.	NOTE (3)
		θ_{x} -		$\theta_y=0^{\circ}$	60	65				
CONTRAST RAT	OF	CR	θx=0°,	θy=0°	300	350			NOTE (3)	
RESPONSE TIME	3	T _R (rise)	Δv-0°	Δv.—0.0		15	30	msec	NOTE (4)	
KESI ONSE TIVII	KESPONSE HME		$\theta x=0^{\circ}, \ \theta y=0^{\circ}$			35	50	msec	NOTE (4)	
	WHITE	Wx			0.26	0.31	0.36			
	WHILE	Wy			0.30	0.35	0.40			
COLOD OF	RED	Rx			0.56	0.61	0.66			
COLOR OF CIE		Ry	$\theta x=0^{\circ}$, $\theta y=0^{\circ}$		0.31	0.36	0.41	<u> </u>	NOTE (5)	
COORDINATE	GREEN	Gx	IF = 40mA NTSC : 50 %		0.28	0.33	0.38		NOTE (3)	
COORDINATE	UKEEN	Gy		0.51	0.56	0.61				
	BLUE	Bx			0.09	0.14	0.19			
BLUE		Ву			0.07	0.12	0.17			
THE BRIGHTNESS		В			400	450		cd/m ²		
OF MODULE		D		θy=0°	400	430 —		cu/m	NOTE (6)	
THE UNIFORMIT	ГҮ ОБ	_	IF = 2	40mA	75	80	_	%	NOTE (6)	

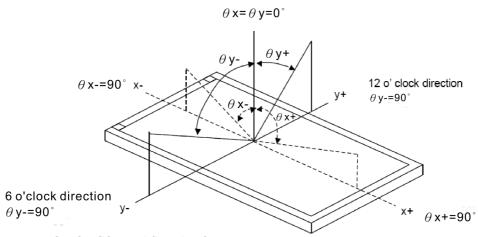
NOTE (1): TEST EQUIPMENT SETUP:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



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NOTE (2): DEFINITION OF VIEWING ANGLE:

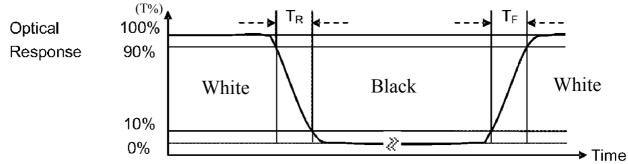


Normal

NOTE (3): DEFINITION OF CONTRAST RATIO:

 $\label{eq:contrast_ratio} \text{CONTRAST RATIO(CR)} = \frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$

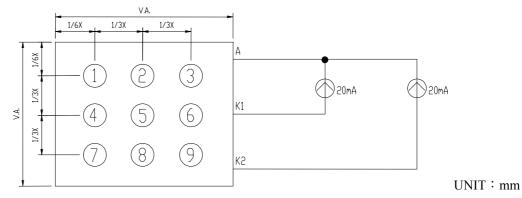
NOTE (4) : DEFINITION OF RESPONSE TIME : T_R AND T_F THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



NOTE (5): THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.

NOTE (6): BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"

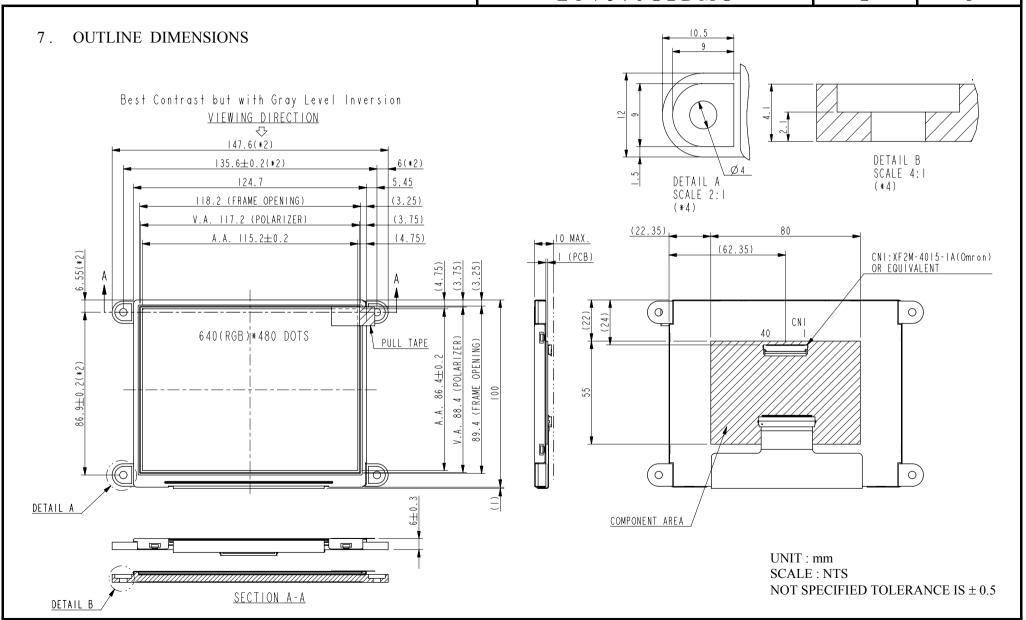
6.2 THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY



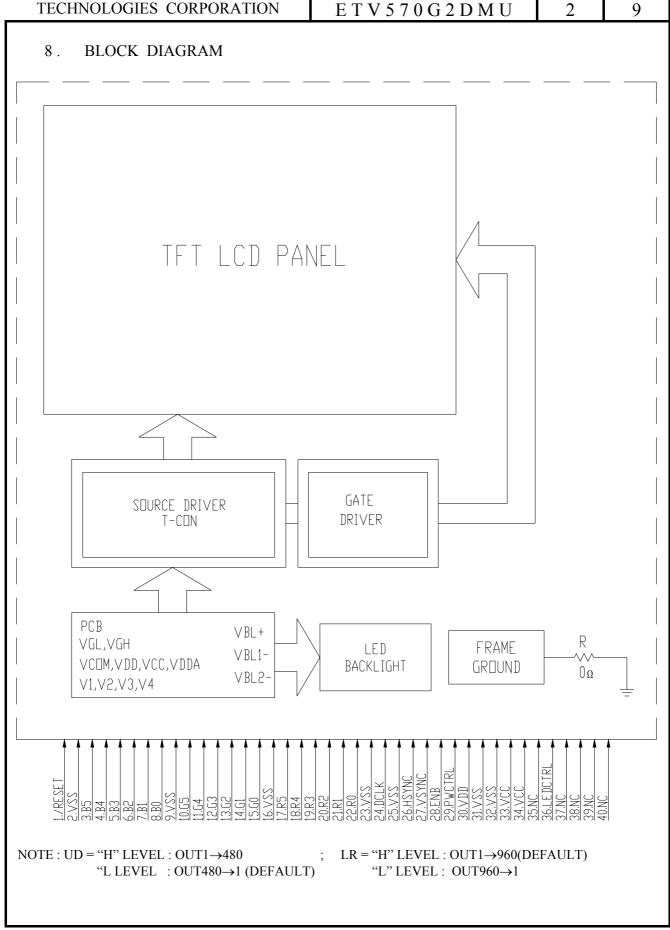
6.3 THE CALCULATING METHOD OF UNIFORMITY

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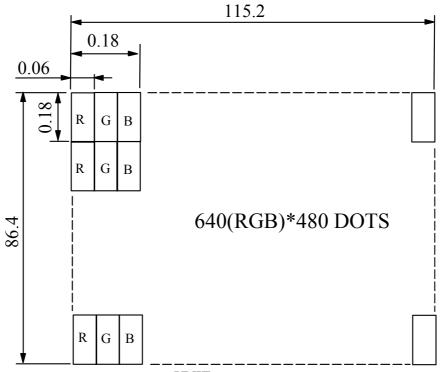


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UNIT : mm SCALE : NTS

NOT SPECIFIED TOLERANCE IS \pm 0.1 DOTS MATRIX TOLERANCE IS \pm 0.01

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10. INTERFACE SIGNALS

PIN NO	SYMBOL	I/O	FUNCTION
1	/RESET	I	HARDWARE RESET
2	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
3	B5	Ι	BLUE DATA BIT 5
4	B4	I	BLUE DATA BIT 4
5	В3	I	BLUE DATA BIT 3
6	B2	I	BLUE DATA BIT 2
7	B1	Ι	BLUE DATA BIT 1
8	В0	Ι	BLUE DATA BIT 0
9	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
10	G5	I	GREEN DATA BIT 5
11	G4	I	GREEN DATA BIT 4
12	G3	I	GREEN DATA BIT 3
13	G2	I	GREEN DATA BIT 2
14	G1	I	GREEN DATA BIT 1
15	G0	Ι	GREEN DATA BIT 0
16	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
17	R5	I	RED DATA BIT 5
18	R4	I	RED DATA BIT 4
19	R3	I	RED DATA BIT 3
20	R2	I	RED DATA BIT 2
21	R1	I	RED DATA BIT 1
22	R0	I	RED DATA BIT 0
23	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
24	DCLK	I	DOT DATA CLOCK
25	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
26	HSYNC	I	HORIZONTAL SYNC INPUT
27	VSYNC	I	VERTICAL SYNC INPUT
28	ENB	I	DATA ENABLE INPUT

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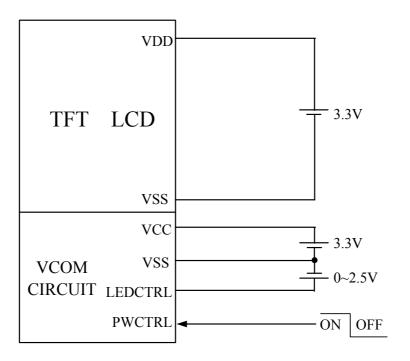
 E T V 5 7 0 G 2 D M U
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PIN NO	SYMBOL	I/O	FUNCTION						
				PWCTRL	REMARK				
			LOGIC LEVEL	Н	POWER ON				
29	PWCTRL	I	H=3.3V L=0V	L	SHUTDOWN				
			WHEN INTERNAL LE	D DRIVER : JP15 1-2(DF	EFAULT)				
			WHEN EXTERNAL LE	ED DRIVER : JP15 2-3					
30	VDD	P	POWER SUPPLY FOR	DIGITAL CIRCUIT					
31	VSS	P	GROUND (VSS IS CONCONDUCTIVE TAPE)	NNECTED TO METAL F	IOUSING WITH				
32	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)						
33	VCC	P	POWER SUPPLY FOR VCOM DRIVER CIRCUIT						
34	VCC	P	POWER SUPPLY FOR VCOM DRIVER CIRCUIT						
35	NC	_	NON CONNECTION (USING INTERNAL LED DRIVER) OR ANODE (USING EXTERNAL LED DRIVER) WHEN INTERNAL LED DRIVER: JP5 1-2 (DEFAULT) WHEN EXTERNAL LED DRIVER: JP5 2-3						
36	LEDCTRL	I	BRIGHTNESS CONTROL FOR LED BACKLIGHT; LEDCTRL (USING INTERNAL LED DRIVER) OR CATHODE (USING EXTERNAL LED DRIVER) WHEN INTERNAL LED DRIVER: JP6 1-2 (DEFAULT) JP14 1-2 (DEFAULT) WHEN EXTERNAL LED DRIVER: JP6 2-3 JP14 NON CONNECTION						
37	NC	_							
38	NC		NON CONNECTION						
39	NC	_							
40	NC								

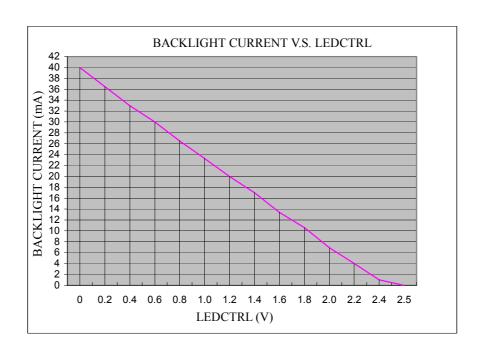
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11. POWER SUPPLY

11.1 POWER SUPPLY FOR LCM



11.2 THE BRIGHTNESS CONTROLLED BY BACKLIGHT CURRENT OF LEDCTRL



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12. INSPECTION CRITERION

12.1 APPLICATION

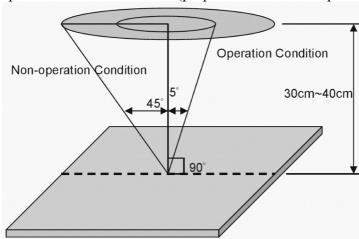
This inspection standard is to be applied to the LCD module delivered from EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) to customers

12.2 INSPECTION CONDITIONS

12.2.1 (1)Observation Distance: 35cm±5cm

(2) View Angle:

Non-operation Condition : ±5°(perpendicular to LCD panel surface) Operation Condition : ±45° (perpendicular to LCD panel surface)



12.2.2 Environment Conditions:

Amb	ient Temperature	20°C~25°C		
Am	bient Humidity	65±20%RH		
Ambient	Cosmetic Inspection	More than 600Lux		
Illumination Functional Inspection		300~500 Lux		

12.2.3 Inspection lot

Quantity per delivery lot for each model

12.2.4 Inspection method

A sampling inspection shall be made according to the following provisions to judge The acceptability

(a) Applicable standard: MIL-STD-105E

Normal inspection, single sampling

Level II

(b)AQL : Major defect : AQL 0.65 Minor defect : AQL 1.0

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12.3 INSPECTION STANDARDS

12.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	1.DISPLAY ON	DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC	
MAJOR DEFECT	2.BACKLIGHT	NO LIGHT FLICKERING AND OTHER ABNORMAL ILLUMINATION	0.65
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
	1.DISPLAY ZONE	 BLACK/WHITE SPOT BUBBLES ON POLARIZER NEWTON RING BLACK/WHITE LINE SCRATCH CONTAMINATION LEVER COLOR SPREED 	
MINOR DEFECT	2.BEZEL ZONE	STAINSSCRATCHESFOREIGN MATTER	1.0
	3.SOLDERING	 INSUFFICIENT SOLDER SOLDERED IN INCORRECT POSITION CONVEX SOLDERING SPOT SOLDER BALLS SOLDER SCRAPS 	
	4.DISPLAY ON (ALL ON)	• LIGHT LINE	

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12.3.2 MODULE DEFECTS CALSSIFICATION

NO.	ITEM	CRITERIA				
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC				
2.	OVERALL DIMENSIONS	(1)OVERALL DIM	IENSION BEYOND	SPEC		
3.	DOT DEFECT	AND BLUE SC (2) I BRIGHT DOT DARK DOT TOAL BRIGHT NOTE: 1. THE DEFINITIO THE SIZE OF A REGARDED AS 2. BRIGHT DOT: DOTS APPEAR PANEL IS DISPI 3. DARK DOT: DOTS APPEAR DOTS APPEAR	REENS. TEMS AND DARK DOTS ON OF DOT: DEFECTIVE DOT ONE DEFECTIVE BRIGHT AND UNCLAYING UNDER B DARK AND UNCH	CHANGED IN SIZE IN	E DOT IS N WHICH LCD	
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA		WIDTH: W $W \le 0.05$ $0.05 < W \le 0.1$ $0.1 < W$	PERMISSIBLE NO. IGNORE 4 NONE		
5.	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	AVERAGE DIAM D ≤ 0.15 <	METER (mm): D 0.15 D≤0.5 < D	NUMBER OF PIECES IGNORE 4 NONE		

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NO.	ITEM		CRITERIA				
			AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED			
		DUDDI E ON THE	D ≤ 0.25	IGNORE			
		BUBBLE ON THE POLARIZER	$0.25 < D \le 0.5$	N ≤ 5			
		IOLARIZER	0.5 < D	NOTE			
		SURFACE STATUS	D < 0.1 mm	IGNORE			
		SORTACE STATES	$0.1 < D \le 0.3 mm$	$N \leq 3$			
		CF FAIL / SPOT	D < 0.1 mm	IGNORE			
			$0.1 < D \le 0.3$ mm	N ≤ 3			
6.	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA. (2)THE EXTRANEOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON. (3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING. AVERAGE DIAMETER (D)=(a+b)/2					
7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOW					
8.	MURA ON DISPLAY	IT'S OK IF MURA IS	SLIGHT VISIBLE THROU	NG 6% ND FILTER			
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.					
10.	BEZEL APPEARANCE	PRINTS STAINS O	HAVE RUST, BE DEFORM F OTHER CONTAMINATI MPLY WITH JOB SPECIFION	ION.			
11	РСВ	THE SEAL AREA (THAN THREE PLA (2)NO OXIDATION O (3)PARTS ON PCB M CHARACTERISTIC THERE SHOULD B PARTS. (4)THE JUMPER ON C CHARACTERISTIC (5)IF SOLDER GETS	OR CONTAMINATION PCE UST BE THE SAME AS OF CCHART. SE NO WRONG PARTS, M THE PCB SHOULD CONFO	E SHOULD BE NO MORE B TERMINALS. N THE PRODUCTION ISSING PARTS OR EXCES ORM TO THE PRODUCT ED PAD, ZEBRA PAD OR			

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NO. ITEM CRITERIA		
	SOLDERING	CRITERIA (1)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET 1/2 SOLDER FILLET SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED SOLDER SOLDER SOLDER SOLDER SOLDER SOLDER SOLDER SOLDER

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NO.	O. ITEM CRITERIA	
	SOLDERING	(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
12. SOLDER		
		 (4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. (6)NO RESIDUE OR SOLDER BALLS ON PCB. (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.
13. BACKL	IGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
14. GENER APPEA		 (1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. (2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP. (3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. (4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. (5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. (6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. (7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. (8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. (9)LCD PIN LOOSE OR MISSING PINS. (10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. (11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. (12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.

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NO.	ITEM	CRITERIA THE LCD WITH EXTENSIVE CRACK IS NOT ACCEPTABLE			
15. CRA		GENERAL GLASS CHIP:		b < VIEWING AREA ≤ W/2 E BETWEEN AREA AND LO OGE E LENGTH	c ≤ 1/8X ≤ 1/8X
	CRACKED GLASS	CHIP ON ELECTRODE PAD	$\begin{array}{c c} & a \\ & \leq t/2 \\ & > t/2 & , \leq 2t \\ \hline *W=DISTANCI \\ SEALANT \\ PANEL EL \\ X = LCD SIDI \\ t = GLASS TI \\ \hline \\ & a \\ & \leq t \\ \hline * X=LCD SIDE \\ t = GLASS TI \\ \hline \end{array}$	AREA AND LODGE E LENGTH HICKNESS b ≤ 0.5mm	c ≤ 1/8X ≤ 1/8X CD
		c a	*X=LCD SIDE t = GLASS TH L=ELECTROI DIF GLASS CH TERMINAL, REMAIN AN ACCORDING TERMINAL 2 IF THE PROI SEALED BY	b ≤1/8X WIDTH HICKNESS DE PAD LENGT HIPPING THE IT , OVER 2/3 OF T ND BE, INSPECT G TO ELECTRO SPECIFICATIO DUCT WILL BE THE CUSTOM MENT MARK M	FO FHE ITO MU FED DDE DNS HEAT ER,

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12.4 RELIABILITY TEST

12.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION
1	High temperature operation	The sample should be allowed to stand at +70°C for 240 hrs
2	Low temperature operation	The sample should be allowed to stand at -20°C for 240 hrs
3	High temperature storage	The sample should be allowed to stand at +80°c for 240 hrs
4	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hrs
5	High temp / humidity test storage	The sample should be allowed to stand at 60°C, 90% RH 240 hrs
6	Thermal shock (not operated)	The sample should be allowed to stand the following 10 cycles of operation: -40°c for 30 minutes ~ +85°c for 30 minutes
7	ESD (Electrostatic Discharge) (not operated)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV

NOTE (1): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

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12.5 TESTING CONDITIONS AND INSPECTION CRITERIA

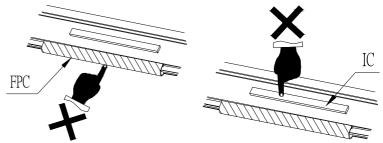
For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in table 12.5, standard specifications for reliability have been executed in order to ensure stability.

NO	ITEM	TEST MODEL	INSPECTION CRITERIA	
1	Current		The current consumption should	
1	consumption	Ketel 10 Specification	conform to the product specification.	
			After the tests have been executed,	
2	Contrast	*	the contrast must be larger than half	
			of its initial value prior to the tests.	
3	Appearance	Visual inspection	Defect free	

12.6 OPERATION

- 12.6.1 Do not connect or disconnect modules to or from the main system while power is being supplied .
- 12.6.2 Use the module within specified temperature; lower temperature causes the retardation of blinking speed of the display; higher temperature makes overall display discolor. When the temperature returns to normality, the display will operate normally.
- 12.6.3 Adjust the LC driving voltage to obtain the optimum contrast .
- 12.6.4 Power On Sequence input signals should not be supplied to LCD module before power supply voltage is applied and reaches the specified value . If above sequence is not followed, CMOS LSIs of LCD modules may be damaged due to latch up problem .
- 12.6.5 Not allowed to inflict any external stress and to cause any mechanical interference on the bending area of FPC during the tail bending backwards!

 Do NOT stress FPC and IC on the Module!



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12.7 NOTICE

- 12.7.1 Use a grounded soldering iron when soldering connector I/O terminals . For soldering or repairing , take precaution against the temperature of the soldering iron and the soldering time to prevent peeling off the through-hole-pad .
- 12.7.2 Do not disassemble . EDT shall not be held responsible if the module is disassembled and upon the reassembly the module failed .
- 12.7.3 Do not charge static electricity, as the circuit of this module contains CMOS LSIs. A workman's body should always be static-protected by use of an ESD STRAP. Working clothes for such personnel should be of static-protected material.
- 12.7.4 Always ground the electrically-powered driver before using it to install the LCD module. While cleaning the work station by vacuum cleaner, do not bring the sucking mouth near the module; static electricity of the electrically-powered driver or the vacuum cleaner may destroy the module.
- 12.7.5 Don't give external shock.
- 12.7.6 Don't apply excessive force on the surface.
- 12.7.7 Liquid in LCD is hazardous substance. Must not lick and swallow. When the liquid is attach to your, skin, cloth etc. Wash it out thoroughly and immediately.
- 12.7.8 Don't operate it above the absolute maximum rating.
- 12.7.9 Storage in a clean environment, free from dust, active gas, and solvent.
- 12.7.10 Store without any physical load.
- 12.7.11 Rewiring: no more than 3 times.